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Sheet 1 of 1

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Application Number	Not yet a seigned			
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First Named Inventor	Makoto UEKI			
Art Unit	Not yet assigned			
Examiner Name	Not yet assigned			
Attorney Docket Number	Q88465			

			U.S.	PATENT DOCUM	ENTS
		Document Number			
	Cite No. ¹	Number	Kind Code ¹ (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
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	Cite	Foreign Patent Document			Publication Date	Name of Patentee or	
	No.1	Country Code ³	Number ⁴	Kind Code ⁵ (if known)	MM-DD-YYYY	Applicant of Cited Document	Translation*
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	<i>A</i>	NON PATENT LITERATURE DOCUMENTS					
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Aλ		E.T. Ogawa et al., "Stress-Induced Voiding Under Vias Connected To Wide Cu Metal Leads", Proceedings of IEEE International Reliability Physics Symposium 2002, USA, The Electron Device Society and The Reliability Society of the Institute of Electrical and Electronics Engineers, Inc, April 7, 2002, Pages 312-321					

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